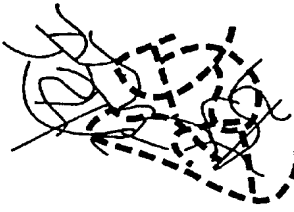


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<b>(54) Title:</b> VIBRATION DAMPING CONSTRUCTIONS USING THERMALLY POLYMERIZED EPOXIDES  		
<b>(57) Abstract</b> <p>A vibration damping material and articles are fabricated using a curable composition comprising a mixture of at least one free radically polymerizable monomer, at least one epoxy functional monomer, at least one free radical polymerization initiator, a thermal initiated cationic catalyst system comprising a salt of an organometallic cation, optionally, at least one stabilizing additive, and optionally, at least one alcohol-containing material, wherein when cured the curable composition provides a vibration damping material with an interpenetrating network comprising a semi-phase separated morphology.</p>		

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# VIBRATION DAMPING CONSTRUCTIONS USING THERMALLY POLYMERIZED EPOXIES

## Technical Field

5            This invention relates to vibration-damping constructions and more particularly to vibration-damping constructions prepared from at least a single layer of a polymerized epoxy-acrylate thermoset resin, wherein the epoxy is thermally polymerized.

**Background of the Invention**

As technology moves toward energy conservation with the concomitant drive towards light weight structures that move at faster speeds and operate at higher temperatures, acoustic and vibratory responses become larger and less desirable.

15 In general, damping materials are applied to structures and component parts in devices to attenuate resonant vibrations thereby reducing noise and vibrational fatigue. This is often accomplished by attaching a viscoelastic material of appropriate damping characteristics to the vibrating structure. Vibrational forces cause the viscoelastic material  
20 in constrained layers to undergo shear deformation where some of its inelastic deformation energy is converted to heat and then dissipated (mechanical hysteresis). Under cyclic loading, heat generated results in a temperature rise until heat generated per cycle is equal to heat dissipated through conduction, convection and radiation. The ability of a material to  
25 damp is measured by its ability to convert vibrational energy to heat energy.

It has long been known that the vibration of component parts of devices and structures that vibrate under the influence of an applied internal or external force can be substantially reduced by the attachment

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of a layer of viscoelastic material. See for example, U.S. Patent Nos. 3,640,836, 3,847,726, 3,833,404 and 4,447,493.

Although epoxies have traditionally been used as constraining layers in damping constructions since they do not exhibit any significant damping due to their highly crosslinked networks, there are several examples of compositions using an epoxy or mixture of epoxies in combination with other materials for use as vibration damping materials. Some examples include (1) damping composite comprising a resin matrix of about 20 to 43% by weight of a flexible epoxy, about 12 to 35% by weight of a stiff epoxy, about 35 to 61% by weight of a flexible crosslinking agent and about 20 to 50% by weight of a high modulus graphite fiber, (2) a process of using compositions comprising certain thermoplastic elastomeric polymers for damping and damping compositions comprising soft thermoset polymer containing microscopically discrete segments of said thermoplastic elastomeric polymers and (3) a method for preparing epoxy/acrylate damping materials by a photoactivation process.

Interpenetrating networks (IPNs) have been previously shown to be useful as vibration damping materials. IPNs generally consist of two or more distinct, mechanically interlocked polymer networks, that can be prepared either in one step (simultaneous IPNs), or in multi-steps (sequential IPNs). During IPN formation a number of phases, comprized of varying amounts of each component can be formed. Morphology is a term used to describe such an aggregate molecular architecture of the IPNs.

Previously disclosed multi color curing process for curing epoxy/acrylates suffers from several complicating factors that render its implementation in the production of constrained layer dampers rather cumbersome. Firstly, a typical vibration damping treatment calls for opaque, commonly metallic, constraining layers. The multi-color curing process can not be easily utilized, since the light, or a similar photoradiation, can not be readily admitted through metal plates. Furthermore, radiation cure is not commonly available at metal coil coating

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facilities, where constrained layer dampers are typically laminated or coated.

Secondly, IPNs comprising higher  $T_g$  thermosets can not be prepared with photocure alone. Such networks require thermal post-cure after photoactivation of the cure. Thus, the two color cure in this case is actually comprised of three steps: photocure of the low  $T_g$  network, photo-activation of the higher  $T_g$  polymer, and finally, its thermal cure.

### Summary of the Invention

10 In one aspect, a curable composition is provided comprising a mixture of at least one free radically polymerizable monomer, at least one epoxy functional monomer, at least one free radical polymerization initiator, a thermal initiated cationic catalyst system comprising a salt of an organometallic cation, wherein upon curing the curable mixture  
15 provides a vibration damping material with an interpenetrating network comprising a semi-phase separated morphology. The curable composition can further comprise at least one stabilizing additive and/or at least one alcohol-containing material.

In another aspect of this invention a vibration damping construction  
20 is provided comprising:

- (1) at least one substrate;
- (2) a cured viscoelastic layer coated on the substrate comprising an interpenetrating network of (a) at least one free radically polymerizable monomer, (b) at least one epoxy functional resin, (c) at least one free  
25 radical polymerization initiator, and (d) a thermally-initiated cationic catalyst system comprising (i) at least one salt of an organometallic cation, wherein the organometallic cation is selected from a class of substituted and unsubstituted aromatic compounds based on a benzene or cyclopentadienyl nucleus, the metal is a transition metal, and the anion is  
30 tetrafluoroborate, hydroxypentafluoroantimonate, trifluoromethanesulfonate, hexafluorophosphate, hexafluoroarsenate, or hexafluoroantimonate; and (ii) optionally, at least one stabilizing additive;

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(e) optionally, at least one alcohol-containing material; and (f) optionally, additional adjuvants.

In another aspect of this invention, a vibration damping construction is provided comprising:

- 5 (a) a first substrate;
- (b) the cured viscoelastic layer as described above coated on at least one surface of the first substrate;
- (c) optionally, a second substrate positioned over the viscoelastic layer such that the layer is sandwiched between the first and
- 10 second substrates.

In another aspect, this invention describes a method for preparing a vibration and sound absorbing construction comprising the steps of:

- (1) providing a first substrate;
- (2) preparing a curable mixture as described above comprised of
- 15 a (a) at least one free radically polymerizable monomer, (b) at least one epoxy functional resin, (c) at least one free radical polymerization initiator, and (d) thermally-initiated catalyst system comprising
- (i) at least one salt of an organometallic cation having the formula;



wherein:

M is selected from the group consisting of Cr, Mo, W, Mn, Re, Fe, Ru, and Os;

25  $L^1$  represents ligands contributing  $\pi$ -electrons that can be selected from substituted and unsubstituted aromatic compounds and substituted and unsubstituted heterocyclic aromatic compounds, and capable of contributing six  $\pi$ -electrons to the valence shell of M;

$L^2$  represents ligands contributing  $\pi$ -electrons that can be selected from substituted and unsubstituted cyclopentadienyl and indenyl anions, and capable of contributing six  $\pi$ -electrons to the valence shell of

30 M;

m and p are integers having a value of 0 or 2, such that, when m is equal to 2, each  $L^1$  may be the same or different ligands and p is equal to

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O; and when p is equal to 2, each  $L^2$  may be the same or different ligands and m is equal to 0, provided the sum of (m + p) is equal to 2;

q is an integer having a value of 1 or 2, the residual charge of the

5 complex cation;

X is an anion selected from organic sulfonate anions selected from the

group consisting of  $CH_3SO_3^-$ ,  $CF_3SO_3^-$ ,  $C_6H_5SO_3^-$ ,

p-toluenesulfonate, p-chlorobenzenesulfonate and related isomers,

and halogen-containing complex anions of a metal or metalloid

10 selected from the group consisting of  $BF_4^-$ ,  $AsF_6^-$ ,  $PF_6^-$ ,  $SbF_5OH^-$ ,  $SbF_6^-$ , and  $CF_3SO_3^-$ ; and

n is an integer having a value of 1 or 2, the number of complex anions required to neutralize the charge q on the complex cation, and

(ii) optionally, at least one stabilizing additive;

15 (3) coating the curable mixture onto the first substrate;

(4) exposing the coating to energy to at least partially cure component (a) by activating the free radical initiator;

(5) laminating the partially cured coating between the first substrate, and a second substrate; and

20 (6) exposing the laminate to a temperature sufficient to cure component (b) to provide a fully cured coating laminated between the first and second substrates.

Alternatively, the first substrate can be a releasable carrier web, wherein component (a) is at least partially cured, and then laminated onto  
25 a second substrate, after which the releasable carrier web is removed and a third substrate is added to form a sandwich with the viscoelastic material between the second and third substrate. This laminate is then exposed to a temperature sufficient to cure component (b) to provide a fully cured coating.

30 The process of the present invention has a unique advantage in preparation of a constrained layer vibration damping article, where photopolymerization is not possible.

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The process provides kinetic control over the polymerization and phase separation by allowing a controllable sequential thermal activation of catalysts to permit polymerization of each component separately. One means of controlling the kinetics of the reaction is by exerting control over the viscosity of the free radically polymerizable monomer. Such control can be attained through partially polymerizing the free radically polymerizable monomer.

Furthermore, the thermal polymerization process of the present invention provides the ability to polymerize monofunctional acrylates in the presence of oxygen, thus eliminating the need to coat and cure the polymerization mixture in an inert atmosphere.

Advantageously, the viscoelastic damping polymeric materials can be prepared either solely by use of heat or via a sequential combination of radiation and heat by utilizing thermal catalysts. The processes taught herein have the further advantage in the ease of geometric fabrication of the constrained layer damping devices or dampers, which need not be viscoelastic at room temperature, for high temperature damping. Construction of constrained layer dampers is greatly facilitated by thermally curing the epoxy/acrylate mixture between two opaque sheets. Methods for curing a liquid coating or a pressure sensitive adhesive *in situ* between two opaque constraining layers are described below.

As used in this application:

"(meth)acrylate-containing" means materials that are essentially free of (meth)acrylic acid, but contain an (meth)acrylate monomer, a mixture of (meth)acrylate monomers, or an (meth)acrylate-epoxy mixture, and further (meth)acrylate and (meth)acrylic include acrylate and methacrylate and acrylic and methacrylic, respectively;

"B-stage" means an intermediate stage in a thermosetting resin reaction in which the material softens when heated, and swells, but does not dissolve in certain liquids. (From ASTM Standard D907-91b);

"bireactive monomer" means a monomer that contains at least two free radically polymerizable groups or two cationically polymerizable groups and does not contain both types of groups, simultaneously;



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"bifunctional monomer" means a monomer that contains both at least one free radically polymerizable group and at least one cationically polymerizable group;

5 "constrained layer" means a damping configuration comprising the component or structure to be damped, a viscoelastic layer, and one or more constraining layers;

"cure" and "polymerize" are used interchangeably in this application to indicate a chemical reaction, usually carried out with a catalyst, heat, light, or any combination of the two, in which many relatively simple  
10 molecules combine to form a chain-like macromolecule;

"epoxy-acrylate thermoset resin composition" is used to indicate uncured compositions, comprising at least one free radically polymerizable monomer, at least one epoxy monomer, at least one free radical initiator, and a thermally activatable curing system, and other adjuvants such as  
15 fillers, dyes, flame retardants, such that the uncured compositions can be cured to a "cured epoxy-acrylate thermoset resin";

"IPN" refers to interpenetrating networks (IPN) wherein all the components are crosslinked and physically interlocked and to semi-interpenetrating networks (sIPN) wherein only some of the components  
20 are crosslinked;

" $T_g$ " means glass-rubber transition temperature;

"thermoplastic" means a high polymer that softens when exposed to heat and solidifies when cooled to room temperature; and

"thermoset" means a high polymer that solidifies or "sets"  
25 irreversibly when cured and this property is typically associated with a crosslinking reaction of the constituents.

### Brief Description of the Drawings

Figures 1 (a-c) schematically illustrate a fully miscible  
30 interpenetrating network (IPN) morphology:

1 (a): schematically represents phase separation of the polymer chain in a miscible IPN;

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1 (b): schematically represents a dynamic mechanical analysis (DMA) curve of this morphology; and

1 (c): schematically represents a transmission electron micrograph (TEM) of this morphology.

5        Figures 2 (a-c) schematically illustrate a phase separated interpenetrating network (IPN) morphology:

2 (a): schematically represents phase separation of the polymer chain in a phase separated IPN;

10        2 (b): schematically represents a DMA curve of this morphology; and

2 (c): schematically represents a TEM of this morphology.

Figures 3 (a-c) schematically illustrate a partially miscible interpenetrating network (IPN) morphology:

15        3 (a): schematically represents phase separation of the polymer chain in a partially miscible IPN;

3 (b): schematically represents a DMA curve of this morphology; and

3 (c): schematically represents a TEM of this morphology.

Figure 4 is a TEM of the schematic representation of Figure 3 (c).

20

### Description of the Preferred Embodiment

25        The epoxy-acrylate materials of the present invention exhibit good damping behavior from about -50°C to about 260°C measured at 1 Hz, and as such are suitable as the viscoelastic component in both free-layer and constrained-layer damping constructions. Addition of other thermosets, thermoplastics and elastomers may also affect performance of the compositions.

30        While not wanting to be bound by theory, it appears the preferred viscoelastic damping materials may comprise a combination of polymers and exhibit a microheterogeneous morphology where phase boundaries are diffuse and the minor phase (present in a lesser amount) has a size distribution ranging from 0.01 micrometers ( $\mu\text{m}$ ) to 5  $\mu\text{m}$ . Damping materials that consist of two or more polymers and have macroscopically

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phase separated morphologies (on the order of micrometers) display damping performance at temperatures associated with the  $T_g$ 's of the individual polymers. Conversely, two or more polymers that are mutually soluble and form a single phase exhibit damping over a narrow  
5 temperature range, the same as does a single polymer. Thus, to achieve damping over a broad temperature range a multicomponent system with the proper degree of phase separation is required.

Traditionally, in macroscopically phase separated systems, component polymers have been chosen based on the temperature interval  
10 between their respective  $T_g$ 's so that their individual damping characteristics overlap. However, with a microheterogeneous morphology, damping behavior covering a broad temperature range is possible because there is a gradation of  $T_g$  character resulting from intimate mixing at diffuse interface boundaries.

15 The glass transition range of a two (or more) component (meth)acrylate blend can be broadened by causing phase separation between the components before final polymerization. This can be done by making oligomeric solutions (syrops) of each component, to a certain degree of polymerization, then by mixing of the solutions, some  
20 immiscibility will occur causing the desired phase separation.

IPNs and semi-IPNs are an attractive class of materials for use as damping materials because they have a potential of offering high performance and unique properties from the common and inexpensive polymers and monomers. The ability to prepare them solventlessly as  
25 described herein and in the previous literature render IPNs and semi-IPNs even more commercially interesting. There is also the added feature that IPNs provide coatings with vastly different performance using the same starting components. Such changes can be accomplished by varying the IPN morphology. "Morphology" describes the micro and macro molecular  
30 architecture, and how intimately the components are mixed on a continuum of size scales. The ability to control the resulting IPN morphology provides high performance polymers at low cost.

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The degree of mixing of polymers in an IPN, or the degree and scale of their phase separation defines the properties of the resulting IPN. Typically, high polymers are highly immiscible due to the entropic considerations. In these IPNs thermodynamically incompatible polymers  
5 can be made compatible via kinetic routes described below. Less frequently, polymers of various chemical compositions can have similar solubility parameters and be "naturally" thermodynamically compatible due to chemical interactions or because of physical attraction brought on by the polar interactions, such as hydrogen-bonding, and van der Waal's  
10 forces. If these forces are large enough, the polymers are fully miscible.

### Morphology

The present invention demonstrates how the degree of phase separation in the thermodynamically incompatible interpenetrating  
15 networks can be controlled by two key rates. The rate of polymerization or crosslinking of each component is competing against the rate of diffusion of each polymer. Diffusion rate is driving the system to phase separate, while the polymer growth process counters by physically locking the two networks together. The process of the present invention enables  
20 IPN morphology engineering by manipulating the rates of polymerization and diffusion of the IPN components.

This control is multi-fold: the rates can be varied by the choice of materials, processing and catalytic systems. The materials choice can vary the viscosity or the rigidity of the polymerization medium via the  
25 degree of cross-linking and the  $T_g$ s of the selected individual components. One means of controlling the kinetics of the reaction is by exerting control over the viscosity of the free radically polymerizable monomer. Such control can be attained through partially polymerizing the free radically polymerizable monomer. Media of different viscosities  
30 provide differing barriers to both diffusion and propagation.

Processing can greatly affect the rates by simply changing the order in which the IPN components are polymerized. The energy used to cure the components can be adjusted to affect the rates. Thermal cure

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can be substituted for the photoactivated polymerization to change the pace of the polymerization. The processing can be used to adjust the lag time between the initiation of each cure, thus allowing greater degree of diffusion and therefore, the phase separation.

- 5           The choice of the catalyst or the initiator, and its amount can have a profound effect on the polymerization and its speed. Additives can be used to delay or speed up the cure of the polymer.

- Assuming that the monomeric mixture (or monomer A swelling network, polymer or oligomer B) is a true solution, the degree of  
10 incompatibility of the two polymers, forming the IPN, progressively grows with the increasing molecular weight due to, if nothing else, the entropic considerations. At the same time, the increasing molecular weight translates into increasingly interlocked and intertwined networks of the component polymers. These mechanical interlocks hinder the extensive  
15 phase separation of the incompatible networks.

          Thus, if the polymerization rate is much faster than the diffusion rate, then the growing polymers will not have a kinetic chance to phase separate and will end up "trapped together" at the gel point. Such IPNs will favor the "fully miscible" morphology. See Figure 1, below.

- 20           The intimate degree of mixing the polymer chains experience in such a morphology is depicted in Figure 1A. Figure 1B is a graphic representation of a DMA temperature scan, representative of a miscible IPN. Note that Figure 1B shows one phase with a rather narrow glass transition range.

- 25           If there is a polarity difference between the components of an IPN, then a "stain" can darken the TEM image of the more polar component. A graphic representation of a typical TEM image of a fully miscible IPN shows a featureless grey domain, as shown in Figure 1C.

- In the opposite case of very slow polymerization versus the faster  
30 diffusion, the incompatible components have plenty of time to phase separate and end up forming a "phase separated" IPN structure. Referring to Figure 2 extensive phase separation on the polymer chain level is graphically represented. Figure 2B demonstrates how DMA reveals two

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distinct peaks in  $\tan \delta$ , indicating separated phases with differing  $T_g$ s. A graphical representative of a typical TEM image as illustrated in Figure 2C is very different from the miscible structure of Figure 1C. It shows a contrasting matrix with emphasized domains of dark grey and white domains. The contrast is apparent, even if both phases are continuous over some area scanned.

While not wanting to be bound by theory, the "semi-phase separated" or "microheterogeneously phase separated" IPNs are the ideal morphology choice, if vibration damping over broad temperature ranges is desired. Wide temperature damping in "semi-phase separated" IPNs is a result of an aggregate molecular architecture consisting of a continual spectrum of compositions, ranging from pure low  $T_g$  component to the pure high  $T_g$  component.

The morphology comprised of a continuum of phase compositions is characteristic of an IPN formed under mixed kinetic control conditions. A system that either started out under the polymer growth control and later crossed over to the diffusion control, or visa versa, would encounter a regime of mixed controls in between. The degree of the allowed phase separation continually changes in the IPN formation during the change of the controls. Variable amounts of each component are allowed to diffuse in and out of the domains that are in the process of becoming discrete microheterogeneous particles. It is during this time that the phases are formed with a wide range of variable compositions.

Now referring to Figure 3A, a graphic representation of the varying degrees of chain mixing is illustrated. This chain mixing results in much broader glass transitions, as shown in Figure 3B. A typical TEM, graphically illustrated in Figure 3C and Figure 4 (actual TEM), shows a grey matrix with both lighter grey and darker grey uniform "precipitates".

## Damping Performance

In viscoelastic materials, the maximum amount of energy is dissipated as heat at  $T_g$ . Effectiveness of a viscoelastic material in energy dissipation is evaluated by measuring its viscoelastic response to a

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periodic stress or strain. Results of dynamic mechanical tests are generally given in terms of elastic or storage modulus and viscous or loss modulus.

The angle which reflects the time lag between applied strain and stress is known as delta ( $\delta$ ), and is defined by the ratio called the dissipation factor or loss factor. Tan ( $\delta$ ) is a damping term and is a measure of the ratio of energy dissipated as heat to maximum energy stored in the material during one cycle of oscillation and is proportional to the ratio of the loss modulus to the storage modulus.

Dynamic mechanical criteria used to evaluate high temperature damping performance in a constrained layer geometry 3 point bending mode are as follows:

1. Thermal range where tan ( $\delta$ ) is greater than 0.06,
2. Thermal stability of this range after prolonged exposures to 260°C, and
3. Thermal range where tan ( $\delta$ ) is greater than 0.05 after 100 minutes at 260°C.

Damping materials comprising acrylates and acrylic acid are known to decompose at relatively low temperatures (<160°C). However, acrylate damping materials can be useful below their decomposition temperature, particularly if the materials do not contain acrylic acid, which is known to be a corrosive agent. Advantageously, the preferred process in the present invention provides acrylate-containing damping materials with improved properties, that is, increases of the thermal decomposition temperature over acrylate damping materials, and significantly higher over acrylate/acrylic acid damping materials.

Surprisingly, it has been found that epoxy-acrylate resins, polymerized in the presence of one another to form an interpenetrating network, are useful in high temperature damping applications. These applications call for materials that can survive multiple prolonged exposures to high temperatures without significant loss of damping performance.

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The criteria used to evaluate the coatings of the present invention were thermal stability of the damping performance and the thermal width or broadness of the effective damping range after multiple exposure to 260°C totalling 100 minutes.

5

### Damping Compositions

The present invention provides compositions and articles prepared using controllable multistep thermal polymerization of of the multicomponent multiphase materials, whose various properties can be optimized by kinetically controlling the amount of phase separation. In art known processes, the degree of phase separation is largely fortuitous and depends solely on the oligomeric incompatibilities and degree of crosslinking. A microheterogeneous phase separation is an intermediate state between a completely miscible separation (illustrated in Figures 1(a-c)) and a totally immiscible phase separation (illustrated in Figures 2(a-c)). The monomeric mixture starts out miscible and is thermodynamically driven to phase separate as the polymer molecular weight grows. As the epoxy monomers crosslink and the free radically polymerizable monomers crosslink, the growing polymers physical interweave and interlock, thereby tying the two phases together and kinetically preventing thermodynamically favored immiscibility.

Particularly useful free radically polymerizable monomers are those monomers that (a) have a  $\tan(\delta)_{\max}$  of at least 0.06 when evaluated in a constrained layer geometry, and (b) generally do not interfere with the epoxy polymerization and are miscible with the epoxy monomers. Such free radically polymerizable monomers include (meth)acrylates and vinyl ester functionalized materials. Particularly useful acrylate and methacrylate materials can be monomers and/or oligomers such as (meth)acrylates, acrylic acid esters, and methacrylic acid esters. Such monomers include mono-, di-, or poly- acrylates and methacrylates such as methyl acrylate, methyl methacrylate, ethyl acrylate, isopropyl methacrylate, isooctyl acrylate, acrylic acid, n-hexyl acrylate, stearyl acrylate, allyl acrylate, isobornyl acrylate, isobornyl methacrylate,



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phenoxyethyl acrylate, phenoxyethyl methacrylate, tetrahydrofurfuryl acrylate, tetrahydrofurfuryl methacrylate, cyclohexyl acrylate, cyclohexyl methacrylate, benzyl acrylate, benzyl methacrylate, ethoxyethoxyethyl acrylate, ethoxyethoxyethyl methacrylate, glycerol diacrylate, glycerol triacrylate, tetraethyleneglycol diacrylate, 1,4-butanediol diacrylate, ethyleneglycol diacrylate, diethyleneglycol diacrylate, triethyleneglycol dimethacrylate, 1,6-hexanediol diacrylate, 1,3-propanediol diacrylate, 1,3-propanediol dimethacrylate, trimethylpropane triacrylate, 1,2,4-butanetriol trimethylacrylate, 1,4-cyclohexanediol diacrylate, pentaerythritol triacrylate, pentaerythritol tetraacrylate, pentaerythritol tetramethacrylate, sorbitol hexacrylate, bis[1-(2-acryloxy)]-p-ethoxyphenyl dimethylmethane, bis[1-(3-acryloxy-2-hydroxy)]-p-propoxyphenyl-dimethylmethane, tris-hydroxyethyl isocyanurate trimethacrylate; the bis-acrylates and bis-methacrylates of polyethylene glycols of molecular weight 200-500, copolymerizable mixtures of acrylated monomers such as those disclosed in U.S. Patent No. 4,652,274, and acrylated oligomers such as those disclosed in U.S. Patent No. 4,642,126.

Monofunctional acrylates may be used in combination with multifunctional acrylates, such as di- or poly- acrylates provided that the ratio of monoacrylate to multifunctional acrylates is in the range of 50:50 to 99.999:0.001, and preferably 98:2 to 99.999:0.001.

Epoxy functional monomers useful in practicing this invention are those known to undergo cationic polymerization and include 1,2-, 1,3-, and 1,4-cyclic ethers (also designated as 1,2-, 1,3-, and 1,4-epoxides).

See the "Encyclopedia of Polymer Science and Technology", 6, (1986), 322, for a description of suitable epoxy functional resins. In particular, cyclic ethers that are useful include the cycloaliphatic epoxies such as cyclohexene oxide and the ERL™ series type of resins available from Union Carbide, such as vinylcyclohexene oxide, vinylcyclohexene dioxide, 3,4-epoxycyclohexylmethyl-3,4-epoxycyclohexanecarboxylate, bis-(3,4-epoxycyclohexyl) adipate and 2-(3,4-epoxycyclohexyl 5,5-spiro-3,4-epoxy) cyclohexene-*m*-dioxane; also included are the

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glycidyl ether type epoxy resins such as propylene oxide, epichlorohydrin, styrene oxide, glycidol, the Epon™ series type of epoxy resins available from Shell Chemical Co., including the diglycidyl ether of bisphenol A and chain extended versions of this material such as Epon 828, Epon 1001, 5 Epon 1004, Epon 1007, Epon 1009 and Epon 2002 or their equivalent from other manufacturers, dicyclopentadiene dioxide, epoxidized polybutadiene like the Poly bd™ resins from Elf Atochem, 1,4-butanediol diglycidyl ether, polyglycidyl ether of phenolformaldehyde resole or novolac resin and resorcind diglycidyl ether.

10 The preferred epoxy resins include the ERL™ type of resins, in particular 3,4-epoxycyclohexylmethyl-3,4-epoxycyclohexanecarboxylate, bis-(3,4-epoxycyclohexyl) adipate and 2-(3,4-epoxycyclohexyl-5,5-spiro-3,4-epoxy) cyclohexene-*m*-dioxane and the bisphenol A Epon™ type resins including 2,2-bis-*[p*-(2,3-epoxypropoxy)phenylpropane and chain extended 15 versions of this material. It is also within the scope of this invention to use a blend of more than one epoxy functional resin.

When present, useful alcohol-containing materials include mono- or poly-alcohols and can be used to control rate of epoxy polymerization and polymer diffusion by altering the epoxy cross-link density. Such mono- 20 alcohols can include methanol, ethanol, 1-propanol, 2-propanol, 2-methyl-2-propanol, 1-butanol, 2-butanol, 1-pentanol, neopentyl alcohol, 3-pentanol, 1-hexanol, 1-heptanol, 1-octanol, 2-phenoxyethanol, cyclopentanol, cyclohexanol, cyclohexylmethanol, 3-cyclohexyl-1-propanol, 2-norbornanemethanol, and tetrahydrofurfuryl alcohol.

25 The polyols useful in the present invention can be aliphatic, cycloaliphatic, or alkanol-substituted arene polyols, or mixtures thereof having 2 to 18 carbon atoms and two to five, preferably two to four hydroxy groups. Nonlimiting examples of useful polyols include 1,2-ethanediol, 1,2-propanediol, 1,3-propanediol, 1,4-butanediol, 30 1,3-butanediol, 2-methyl-1,3-propanediol, 2,2-dimethyl-1,3-propanediol, and 2-ethyl-1,6-hexanediol, 1,5-pentane diol, 1,6-hexanediol, 1,8-octanediol, neopentyl glycol, glycerol, trimethylolpropane, 1,2,6-hexanetriol, trimethylolethane, pentaerythritol, quinitol, mannitol, sorbitol, diethylene

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glycol, triethylene glycol, tetraethylene glycol, glycerine, 2-ethyl-2-(hydroxymethyl)-1,3-propanediol, 2-ethyl-2-methyl-1,3-propanediol, pentaerythritol, 2-ethyl-1,3-pentanediol, and 2,2-oxydiethanol, 1,4-cyclohexane dimethanol, 1,4-benzene dimethanol, 2-butene-1,4-diol, and polyalkoxylated bis-phenol A derivatives. Particularly useful diols are cyclohexane dimethanol and hexanediol. Other examples of useful diols are disclosed in U.S. Patent No. 4,503,211.

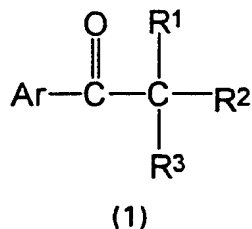
Higher molecular weight polyols include the polyethylene and polypropylene oxide polymers in the molecular weight range of 200 to 20,000 such as the Carbowax™ polyethyleneoxide materials supplied by Union Carbide, caprolactone polyols in the molecular weight range of 200 to 5,000, such as the Tone™ polyol materials supplied by Union Carbide, polytetramethylene ether glycol in the molecular weight range of 200 to 4,000, such as the Terathane™ materials supplied by Dupont, hydroxyl terminated polybutadiene resins such as the Poly bd™ resins supplied by Elf Atochem, or equivalent materials supplied by other manufacturers.

The alcohol-containing material can be present as a mixture of materials and can contain mono- and poly- hydroxyl containing materials. The alcohol-containing material, when present is present in an amount sufficient to provide an epoxy to hydroxy ratio in the composition between about 1:0.1 and 1:1, more preferably between about 1:0.2 and 1:0.8, and most preferably between about 1:0.3 and 1:0.6.

Free-radical initiators can be selected from those compounds that generate free-radicals upon exposure to heat or radiation, for example, those compounds described in "Mechanisms of the Photodecomposition of Initiators" George F. Vesley, Journal of Radiation Curing, January, 1986, or in Chemistry & Technology of UV & EB Formulations for Coatings, Inks & Paints, Volume III, Photoinitiators for Free Radical and Cationic Polymerization, SITA Technology, London, 1991. They are selected from substituted and unsubstituted acetophenones and ketals, benzophenones, aryl glyoxalates and acylphosphine oxides.

Preferred free radical initiators are acetophenones and ketals corresponding to the formula 1:

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wherein  $\text{R}^1$  and  $\text{R}^2$  is  $-\text{OR}^4$ ,  $\text{R}^4$  is an alkyl having 1 to 4 carbon atoms and  $\text{R}^3$  is a phenyl; or  $\text{R}^1$  and  $\text{R}^2$  taken together form an alkylene having 2 to 8 carbon atoms, preferably cyclohexylene, and  $\text{R}^3$  is  $-\text{OH}$  or phenyl. The  
 5 photoinitiator can be a mixture of one or more compounds.

Such compounds have been described, for example, in U.S. Patent Nos. 3,715,293, 3,728,377, 4,284,485 and 4,318,791, such descriptions are incorporated herein by reference.

Examples of the preferred compounds include:

10 2,2-dimethoxyacetophenone, 2,2-dimethoxy-2-phenylacetophenone, 2,2-diethoxyacetophenone, 2,2-dibutoxyacetophenone, 2,2-dimethyl-2-hydroxyacetophenone, 2,2-dimethyl-2-morpholino-(p-thiomethyl) acetophenone and 1-hydroxycyclohexyl phenyl ketone.

15 Peroxides and azo compounds are particularly useful as thermal free radical initiators. Examples of useful peroxide and azo initiators are described in "The Encyclopedia of Polymer Science and Technology, Vol. 11, pp 1-21 (John Wiley & Sons, Inc. 1988) and include, but are not limited to: azo-t-butane, 2-phenylazo-2,4-dimethyl-4-methoxyvaleronitrile,  
 20 2,2'-azobis(2,4,4-trimethyl-pentane), 2-(carbamoylazo)isobutyronitrile, 1,1'-azobis(1-cyclohexanecarbonitrile), 2,2'-azobis(2-methylbutyronitrile), dimethyl 2,2'-azobisisobutyrate, 2,2'-azobisisobutyronitrile, 2,2'-azobis(2,4-dimethyl-valeronitrile), 2,2'-azobis(4-methoxy-2,4-dimethylvaleronitrile), 2,2'-azobis(2,4-dimethylpentane nitrile), 2,2'-  
 25 azobis(2-methylpropanenitrile), 2,2'-azobis(2-methylbutanenitrile), 1,1'-azobis(cyclohexanecarbonitrile).

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Preferred di-alkyl peroxides and azo compounds include azo-t-butane, 2,2'-azobis(2,4,4-trimethyl-pentane) and di-t-butyl peroxide 1,1-di-(t-butylperoxy)-3,3,5-trimethylcyclohexane.

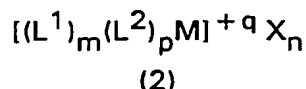
For partially polymerizing free radically polymerizable monomers without crosslinking, and to prepare the syrups described below, the following initiators, either alone or in combination with each other, are found useful and include: the benzoin ethers (such as benzoin methyl ether or benzoin isopropyl ether), substituted benzoin ethers (such as anisoin methyl ether), substituted acetophenones (such as 2,2-diethoxyacetophenone and 2,2-dimethoxy-2-phenylacetophenone), substituted alpha-ketols (such as 2-methyl-2-hydroxypropiophenone), aromatic sulfonyl chlorides (such as 2-naphthalene-sulfonyl chloride) and photoactive oximes [such as 1-phenyl-1,1-propanedione-2(o-ethoxycarbonyl)oxime].

In preparing a free radically polymerizable syrup, the initiators may be used in amounts, which as dissolved, provide about 0.001 to 0.5 % by weight of the free radically polymerizable monomer, preferably at least 0.01 % by weight. When used in the final curable composition, the initiators may be used in amounts which, as dissolved, provide about 0.01 to 5.0 % by weight of the free radically polymerizable monomer, preferably 0.1 to 2 % by weight.

Suitable organometallic salts are known in the art and can be prepared as described in, for example, U.S. Patent Nos. 5,089,536, 5,059,701, and 5,191,101, and such description is incorporated herein by reference. Salts of organometallic complex cations can be used as mixtures and isomeric mixtures. Disubstituted ferrocene derivatives can be prepared by the general procedure described in J. Amer. Chem. Soc., 1978, 100, 7264. Ferrocene derivatives can be oxidized to prepare the corresponding ferrocenium salts by the procedure described in Inorg. Chem., 1971, 10, 1559.

The salts of organometallic complex cations useful in the vibration damping compositions of the present invention have formula 2:

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wherein:

M is selected from the group containing Cr, Mo, W, Mn, Re, Fe, Ru, and

5 Os;

$L^1$  represents ligands contributing  $\pi$ -electrons that can be selected from substituted and unsubstituted aromatic compounds and substituted and unsubstituted heterocyclic aromatic compounds, and capable of contributing six  $\pi$ -electrons to the valence shell of M;

10  $L^2$  represents ligands contributing  $\pi$ -electrons that can be selected from substituted and unsubstituted cyclopentadienyl and indenyl anions, and capable of contributing six  $\pi$ -electrons to the valence shell of M;

m and p are integers having a value of 0 or 2, such that, when m is equal to 2, each  $L^1$  may be the same or different ligands and p is equal to 0; and when p is equal to 2, each  $L^2$  may be the same or different ligands and m is equal to 0, provided the sum of (m + p) is equal to 2;

20 q is an integer having a value of 1 or 2, the residual charge of the complex cation;

X is an anion selected from organic sulfonate anions selected from the group consisting of  $CH_3SO_3^-$ ,  $CF_3SO_3^-$ ,  $C_6H_5SO_3^-$ , p-toluenesulfonate, p-chlorobenzenesulfonate and related isomers, and halogen-containing complex anions of a metal or metalloid selected from the group consisting of  $BF_4^-$ ,  $AsF_6^-$ ,  $PF_6^-$ ,  $SbF_5OH^-$ ,  $SbF_6^-$ , and  $CF_3SO_3^-$ ; and

25 n is an integer having a value of 1 or 2, the number of complex anions required to neutralize the charge q on the complex cation.

30 The preferred salts of organometallic complex cations useful in the compositions of the invention are where  $L^1$  is selected from the class of substituted and unsubstituted aromatic compounds based on benzene and  $L^2$  is selected from the class of substituted and unsubstituted compounds

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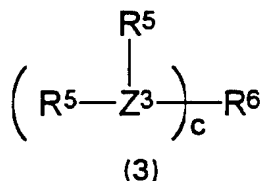
containing a cyclopentadienyl anion, M is Fe and X is selected from the group consisting of tetrafluoroborate, hexafluorophosphate, hexafluoroarsenate, hexafluoroantimonate, hydroxypentafluoroantimonate or trifluoromethanesulfonate.

- 5           Examples of the preferred salts of organometallic complex cations useful in preparing the compositions of the invention include the following:

- bis-( $\eta^6$ -benzene)iron(2+) hexafluoroantimonate  
 bis-( $\eta^6$ -cumene)iron(2+) hexafluoroantimonate  
 10 bis-( $\eta^6$ -durene)iron(2+) hexafluoroantimonate  
 bis-( $\eta^6$ -p-xylene)iron(1+) hexafluoroantimonate  
 bis-( $\eta^6$ -mesitylene)iron(2+) hydroxypentafluoroantimonate  
 bis-( $\eta^6$ -mesitylene)iron(2+) trifluoromethanesulfonate  
 bis-( $\eta^6$ -mesitylene)iron(2+) hexafluoroantimonate  
 15 bis-( $\eta^6$ -hexamethylbenzene)iron(2+) hexafluoroantimonate  
 bis-( $\eta^6$ -pentamethylbenzene)iron(2+) hexafluoroantimonate  
 bis-( $\eta^5$ -methylcyclopentadienyl)iron(1+) hexafluoroantimonate  
 bis-( $\eta^5$ -trimethylsilylcyclopentadienyl)iron(1+) hexafluoroantimonate  
 bis-( $\eta^5$ -triphenyltincyclopentadienyl)iron(1+) hexafluoroantimonate  
 20 bis-( $\eta^5$ -indienyl)iron(1+) hexafluoroantimonate  
 ( $\eta^5$ -cyclopentadienyl)( $\eta^5$ -methylcyclopentadienyl)iron(1+)  
           hexafluoroantimonate  
 bis-( $\eta^5$ -cyclopentadienyl)iron(1+) trifluoromethanesulfonate  
 bis-( $\eta^5$ -trimethylsilylcyclopentadienyl)iron(1+) trifluoromethanesulfonate  
 25 bis-( $\eta^5$ -triphenyltincyclopentadienyl)iron(1+) trifluoromethanesulfonate  
 bis-( $\eta^5$ -cyclopentadienyl)iron(1+) hexafluoroantimonate  
 bis-( $\eta^5$ -cyclopentadienyl)iron(1+) hydroxypentafluoroantimonate

- Useful stabilizing additives several classes of compounds that have segments or central nucleus as described in formulas 3-4. For example,
- 30 the first class of compounds can be described by formula 3:

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wherein

$\text{Z}^3$  is nitrogen, phosphorus, arsenic or antimony;

$\text{R}^5$  is a radical moiety that can be the same or different and is selected

- 5 from substituted and unsubstituted  $\text{C}_1$  to  $\text{C}_{10}$  alkyl groups, substituted and unsubstituted groups of one to four aromatic rings, wherein two to four rings can be fused or unfused rings;

$\text{R}^6$  is  $\text{R}^5$  or a divalent group (as when  $c = 2$ ) selected from alkylene, having 3 to 10 carbon atoms and phenylene groups; or two  $\text{R}^5$

- 10 groups can be taken together to form a cyclic ring having 5 to 7 ring atoms;

$c$  is 1 or 2.

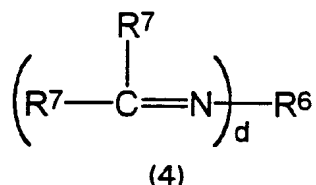
Examples of suitable additives include according to the above formula, but are not limited to trialkyl, tricycloalkyl, tri(alkylcycloalkyl),

- 15 triaryl, trialkaryl amines, such tertiary amines are listed in U.S. Patent No. 4,503,211 and incorporated by reference especially diethyl-o-toluidine, phosphines, phosphites, arsines, stibines such as triphenylphosphine, triphenylstibene, triphenylarsine, tricyclohexylphosphine, tributylphosphine, tripropylphosphine, triethylphosphine, 20 trimethylphosphine, triisopropylphosphine, triisopropylphosphite, tributylphosphite, triphenylphosphite, triethylamine, tripropylamine, tributylamine, and chelating phosphines such as diphenylphosphinomethane, diphenylphosphinoethane, diphenylphosphinopropane. The preferred stabilizers include 25 triarylphosphines, triarylstibines and substituted and unsubstituted dialkylaryl tertiary amines.

Another class of compounds useful as stabilizing additives are those having formula 4:



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wherein

$\text{R}^6$  is as defined above;

$\text{R}^7$  can be hydrogen or  $\text{R}^5$  as defined above; and

5  $d$  is 1 or 2.

These stabilizers are compounds known as Schiff bases and are generally made by the condensation of a ketone or aldehyde with a primary amine. They can be prepared by the general methods described in U.S. Patent No. 4,909,954. In preferred compounds,  $d$  is 1, one  $\text{R}^7$  is a substituted or unsubstituted phenyl group and the other  $\text{R}^7$  is hydrogen, and  $\text{R}^6$  is a substituted or unsubstituted alkyl, phenyl, or alkoxy, or when  $d$  is 2, one  $\text{R}^7$  is a phenyl and the other  $\text{R}^7$  is hydrogen and  $\text{R}^6$  is a diradical bridging an alkylene or phenylene group.

Examples of substituting groups for  $\text{R}^4$  to  $\text{R}^7$ , all of which preferably have less than 30 carbon atoms and up to 10 hetero atoms selected from nitrogen, sulfur, non-peroxidic oxygen, phosphorus, arsenic, selenium, antimony, tellurium, silicon, germanium, tin, and boron, include hydrocarbyl groups such as methyl, ethyl, butyl, dodecyl, tetracosanyl, phenyl, benzyl, allyl, benzylidene, ethenyl, and ethynyl; hydrocarbyloxy groups such as methoxy, butoxy, and phenoxy; hydrocarbylmercapto groups such as methylmercapto (thiomethoxy), phenylmercapto (thiophenoxy); hydrocarbyloxycarbonyl such as methoxycarbonyl and phenoxy carbonyl; hydrocarbylcarbonyl such as formyl, acetyl, and benzoyl; hydrocarbylcarbonyloxy such as acetoxy, and cyclohexanecarbonyloxy; hydrocarbylcarbonamido, for example, acetamido, benzamido; azo, boryl; halo, for example, chloro, iodo, bromo, and fluoro; hydroxy; cyano; nitro; nitroso, oxo; dimethylamino; diphenylphosphino, diphenylarsino; diphenylstibine; trimethylgermane;

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tributyltin; methylseleno; ethyltelluro; and trimethylsiloxy; condensed rings such as phenyl, cyclopentyl; naphthyl, and indenyl.

### Method of Preparation

5           A process for this invention is provided, wherein polymerization of epoxy monomers and free radically polymerizable monomers in the presence of each other produces interpenetrating polymeric networks. This environmentally friendly process is solventless and produces the cured mixture of the epoxy resins and free radically polymerizable resins  
10 by application of heat in one or multiple steps with and without prior irradiation.

The process comprises:

- (a) admixing at least one partially polymerized free radically polymerizable monomer, at least one epoxy monomer, at least one free  
15 radical initiator, and a thermally initiated cationic catalyst system, which comprises at least one organometallic complex salt, and optionally, at least one stabilizer,
- (b) coating the admixture on at least a portion of one surface of a substrate, and  
20 (c) applying heat to the admixture with a heating means.

The resin composition comprises a syrup, that is a mixture of partially polymerized free radical monomers (0.001% to 15.0% conversion), substantially unpolymerized epoxy monomers, and optional  
25 adjuvants.

#### Method A

A first step in the preparation of the syrup is to mix the polymerizable monomers (cationically and free radically polymerizable monomers) with a catalytically effective amount of a free radical initiator.  
30 Preferably, the free radical initiator is not a crosslinking agent and is generally present in an amount within the range of 0.01 to 5.0% by weight of the polymerizable composition, preferably in the range of 0.02 to 1.0% by weight of the polymerizable composition.

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A second step is to apply energy to the polymerizable composition to allow it to polymerize such that the viscosity is increased to within a range of 300 to 20,000 centipoise (cps) (0.3 to 20.0 Pascal seconds (Pa·sec)) at ambient temperature. Preferably, the viscosity after this step  
5 is in the range of 500 to 4000 cps (0.5 to 4.0 Pa·sec). The increased viscosity provides a syrup that is suitable as a coating composition for production of the articles of the invention. The polymerizable composition may be polymerized using any well-known polymerization technique and quenched with air to attain the desired viscosity. By "quenched" is meant  
10 to inhibit any polymerization or further polymerization. Preferably, the free radical initiator is a photoinitiator, and the partial polymerization may be stopped at any point by eliminating the irradiation source.

A third step is to mix at least one organometallic complex salt and any optional stabilizing additives, alcohol-containing material, bireactive  
15 free radically polymerizable monomer, bifunctional monomer, adjuvants and additional amount of the above-identified free radical initiator into the syrup.

A fourth step is to degas the curable compositions under vacuum to remove bubbles, dissolved air, oxygen, and the like. Although it is  
20 preferable to do this step just prior to coating, it may be carried out at any time from a few hours to several weeks prior to coating. To insure stability of the degassed curable compositions, it is preferable to keep them from unwanted exposure to light.

#### 25 Method B

Alternatively, if the free radically polymerizable composition is derived from a mixture of one or more alkyl (meth)acrylates, a syrup of the free radically polymerizable monomers can be prepared without addition of cationically polymerizable monomers.

30 The first step in the alternative method is to mix the free radically polymerizable monomers with a catalytically effective amount of a free radical initiator. Preferably, this free radical initiator is not a crosslinking agent and generally is present in amounts in the range of 0.01 to 5.0% by

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weight of the free radically polymerizable components, and preferably in the range of 0.02 to 1.0% by weight.

The second step is to apply energy to the polymerizable composition and allow it to polymerize such that the viscosity is increased  
5 to within a range of 300 to 20,000 cps at ambient temperature. Preferably, the viscosity after this step is in the range of 500 to 4000 cps. The increased viscosity provides a syrup that is more suitable as a coating composition for production of articles of this invention.

The polymerizable composition can be polymerized by any well-  
10 known thermal polymerization techniques and quenched with air to attain the desired viscosity. It is preferable to use a photoinitiator as the free radical initiator in this process, such that the partial polymerization may be stopped at any point by eliminating the irradiation source and then quenching polymerization with oxygen. It is preferable to use a low  
15 intensity irradiation source in this photochemical process and that the mixture be cooled during irradiation. Low intensity irradiation and cooling minimize gel formation during the syrup making process. By "cooling" is meant to keep the composition at or below room temperature. After quenching the polymerization reaction, optional bireactive monomers,  
20 bifunctional monomers, adjuvants and additional free radical initiators may be added.

The cationic catalyst system is then added to a cationically polymerizable material. If the cationic initiator is not readily soluble, solution can be aided by application of heat. When heating the cationic  
25 initiator in the presence of the cationically polymerizable material, it is advantageous to reduce exposure of the mixture to light, to minimize the risk of unwanted polymerization. The cationic initiator can also be dissolved in a suitable solvent first and then added to the cationically polymerizable material.

30 It is also permissible to add the optional bireactive monomers, bifunctional monomers, adjuvants and additional free radical initiators to this composition.

The syrup and cationically polymerizable mixture are then mixed together. While it is permissible to mix the components in any order, it is preferable to add the acrylate syrup to the cationically polymerizable mixture. If optional bireactive monomers, bifunctional monomers, 5 adjuvants and additional free radical initiators have not been added previously, they may be added at this time. The composition is thoroughly mixed to evenly distribute the components.

The curable compositions are degassed under vacuum to remove bubbles and dissolved air (oxygen). Although, it is preferable to do this 10 step just prior to coating, degassing can be carried out at any time from a few hours to several weeks prior to coating. To insure stability of the degassed curable compositions, it is preferable to keep the curable composition from unwanted exposure to light.

The preferred method is to combine two or more free radically 15 polymerizable syrups, wherein each syrup is prepared either using Method A or Method B.

### Vibration Damping Articles and Method of Making

A method for preparing a vibration and sound absorbing material 20 comprises the steps:

- (1) providing at first substrate;
- (2) preparing a curable mixture as described above comprised of a (a) at least one free radically polymerizable monomer, (b) at least one epoxy functional resins, (c) at least one free radical polymerization 25 initiator, and (d) thermally-initiated cationic catalyst system comprising
  - (i) at least one salt of an organometallic cation having the formula described above; and
  - (ii) optionally, a stabilizing additive;
- (3) coating the curable mixture onto the first substrate;
- 30 (4) exposing the curable mixture to an energy source to activate the free radical initiator to provide a partially cured coating;
- (5) laminating the partially cured coating between the first substrate, and a second substrate; and

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(6) exposing the laminate to a temperature sufficient to cure component (b) to provide a fully cured coating laminated between the first and second substrates.

For most applications, the viscoelastic layer is a coating having a thickness of at least 0.01 mm up to about 100 mm, preferably 0.025 to 100 mm, and most preferably 0.05 to 100 mm. The coating can be applied to a substrate by any of the techniques known in the art such as by spray, dip, knife, or curtain coating.

A stiff layer or a substrate is an essential part of constrained-layer vibration-damping constructions. A suitable material for a substrate has a stiffness of 0.40 (relative to stainless steel) as defined in Handbook of Tables for Applied Engineering Science 130 (ed. R. Bolz, 1974). The desired stiffness of the substrate is varied by adjusting the thickness of the layer, for example from about 25 micrometers to 5 centimeters, depending on the modulus of the substrate. Examples of suitable materials include metals such as iron, steel, nickel, aluminum, chromium, cobalt and copper, and alloys thereof; stiff thermoplastic materials, such as polystyrene, polyvinyl chloride, polyurethane, polyphenyl sulfide, and polycarbonate; stiff thermoset materials; fiber-reinforced thermoplastics; fiber-reinforced thermosets, such as epoxies, phenolics; ceramic fiber; and metal fiber-reinforced polyester, glasses, and ceramics.

Since the viscoelastic layer generally has some adhesive properties, the epoxy-acrylate thermoset resin could be readily adhered to the vibratory article without use of an adhesive. However, it is sometimes desirable to use a thin layer (for example, 20-50 mm) of a high-modulus adhesive, such as an acrylic adhesive or an epoxy adhesive, to bond the viscoelastic layer to the vibratory article. Advantageously, coating a vibratory article directly allows damping of 3-dimensional (and unusually shaped) articles.

The layer thickness of a free-layer damping construction is generally greater than that for a constrained layer construction, since damping performance of the free-layer construction is a function of the layer thickness, see Kerwin and Ungar, supra.

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The curable compositions may be coated between rigid substrate members and exposed to heat to complete the polymerization.

Furthermore, if desired, both the cationic and the free radically polymerizable components can be initiated either simultaneously or

- 5 sequentially in two discrete thermal steps. In the first thermal cure step either the epoxy component or the acrylate component can be cured, followed at a later time by the thermal cure of the remaining uncured component. These methods are termed "all-thermal initiation processes".

- Alternatively, the compositions may be cured using sequential  
10 exposure to a irradiation (only one frequency) and heated to complete the polymerization (photo-thermal photoinitiation process). In this process the curable composition containing a cationic organometallic catalyst and a free radical photoinitiator is irradiated with UV light. The resultant B-stage coating may be heat cured to form a free-standing, vibration damping  
15 layer. Alternatively, the B-stage coating can be bonded to at least one constraining layer and heat cured to form a tough vibration damping coating. In yet another configuration, the B-stage coating can be used to make a vibration damping composite construction wherein the coating composition makes a heat curable bond between two constraining layers.

- 20 Energy polymerizable compositions of this invention are radiation sensitive in addition to being thermally sensitive. The compositions can be cured in a two stage curing process using radiation followed by heat, heat followed by radiation, or heat followed by heat. Heat can also be applied or removed before or during the irradiation process to promote or  
25 retard the curing of the composition, respectively. The preferred process for curing the curable composition is heat/radiation/heat or heat/heat.

- Articles subject to vibration (vibratory articles) for damping or isolation contemplated in the practice of this invention include, but are not limited to, components of computers, motors, automotives, trucks, ships,  
30 airplanes, public works, buildings and building construction, electric or electronic materials, sporting goods, and the like.

In one variation of the damping construction of the present invention, the acrylate-containing thermoset resin is bonded to a vibratory

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solid article that is to be damped. This application is referred to as a "free" viscoelastic layer, sometimes referred to as "extensional" damping. See Kerwin and Ungar, "Sound and Vibration Damping with Polymers," No. 424 ACS Symposium Series, Chapt. 17, (1989).

5           The epoxy-acrylate thermoset resin can also be used in a three layer laminate comprising in succession a base layer (vibratory solid object) to be damped, a viscoelastic layer, comprising at least one free radically polymerizable monomer at least one epoxy functional monomer and a constraining layer. This application is referred to as a "constrained" viscoelastic layer, sometimes referred to as "shear" damping (Kerwin and Ungar, supra). Furthermore, the resins are useful in variations of the constrained viscoelastic layer configuration, such as a segmented constraining layer, multiple constrained layer treatments, and multiple, overlapping segmented layers.

10           Vibration damping laminates containing epoxy-acrylate thermoset resins may be prepared according processes well known in art, for example, such as those described in U.S. Patent No. 4,447,493, and such description is incorporated herein by reference.

15           The constrained-layer construction can be mechanically or adhesively affixed to the vibratory article that is to be damped. Since the viscoelastic layer has adhesive properties, the cured resin can generally be adhered to a stiff layer or substrate without additional use of adhesives. It is sometimes desirable, however, to use a thin layer (for example, 20-50 mm) of high-modulus adhesive, such as an acrylic adhesive or an epoxy adhesive, to bond the viscoelastic layer to a solid article which can be, for example, an oil pan, a valve cover, or a transmission housing.

20           Objects and advantages of this invention are further illustrated by the following examples, but the particular materials and amounts thereof recited in these examples, as well as other conditions and details, should not be construed to unduly limit this invention. All materials are commercially available or known to those skilled in the art unless otherwise stated or apparent.



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## Glossary

	IOA	isooctyl acrylate (available from Sartomer Co.)
	IBA	isobornyl acrylate (available from Sartomer Co. under the trade designation "SR-506")
	HDDA	1,6-hexanediol diacrylate (available from Sartomer Co. under the trade designation "SR-238")
5	ERL4221	3,4-epoxycyclohexylmethyl-3,4-epoxycyclohexanecarboxylate (available from Union Carbide)
	KB-1	2,2-dimethoxy-1-phenylacetophenone (available from Sartomer Co. or from Ciba Geigy under the trade designation "Irgacure 651")
	VR-110	2,2'-azobis(2,4,4-trimethyl-pentane) (available from Wako Chemical Co.)
	VR-160	azo-t-butane (available from Wako Chemical Co.)
	V-19	2-phenylazo-2,4-dimethyl-4-methoxyvaleronitrile (available from Wako Chemical Co.)
10	V-30	2-(carbamoylazo)isobutyronitrile (available from Wako Chemical Co.)
	Trigonox B	di-t-butyl peroxide (available from Akzo Chemical Co.)
	Trigonox-29	1,1-di-(t-butylperoxy)-3,3,5-trimethylcyclohexane (available from Akzo Chemical Co.)
	Epon 1001F	diglycidyl ether of bisphenol A (epoxy equivalent weight of 525-550 g·eq <sup>-1</sup> ) (available from Shell Chemical Co.)
	Cp <sub>2</sub> FeSbF <sub>6</sub>	bis( $\eta^5$ -cyclopentadienyl)iron(1+) hexafluoroantimonate
15	Mes <sub>2</sub> Fe(SbF <sub>6</sub> ) <sub>2</sub>	bis( $\eta^6$ -mesitylene)iron(2+) hexafluoroantimonate
	Cp(Xyl)FeSbF <sub>6</sub>	( $\eta^5$ -cyclopentadienyl)( $\eta^6$ -xylenes)iron(1+) hexafluoroantimonate
	DEOT	N,N-diethyl o-toluidine

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## Examples

All materials are commercially available except where stated or otherwise made apparent. In the following examples, all amounts are in parts by weight unless otherwise specified or apparent. Specific  
5 temperatures where maximum damping was observed were determined by the glass transition temperature,  $T_g$ , of the particular composition.

## Test Methods

### Dynamic Mechanical Analysis (DMA)

10 Measurements reported were made using a Seiko DMS 110 Rheometer operating in a linear dynamic temperature ramp mode using a 20 mm head for bending of a constrained layer specimen geometry. Results were analyzed in terms of  $E'$ ,  $E''$ , and  $\tan(\delta)$  as a function of temperature. DMA results of illustrative examples are summarized below  
15 and illustrate the high temperature damping characteristics of the preferred damping materials.

### Differential Scanning Calorimetry (DSC)

DSC was used to measure the exothermic heat of reaction  
20 associated with the cure of the epoxy material. This energy is measured in Joule/gram (J/g). The exotherm profile, i.e. peak temperature, onset temperature, etc., of the exotherm provided information on conditions that are needed to cure the material. The onset temperature ( $T_{onset}$ ) is the point of intersection between the tangents drawn to the curve along the  
25 baseline, and after the onset of the exotherm at the point of maximum change in slope. The integrated energy under an exothermic peak is related to the extent of cure. For a stable composition, more of that exotherm energy should remain with time indicating that the composition is not curing prematurely. For an unstable composition, the exotherm  
30 energy will decrease more rapidly with time indicating that the composition has undergone some degree of cure prematurely.

### $^1\text{H}$ Nuclear Magnetic Resonance

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The samples were analyzed using a Varian XL400 FT NMR. <sup>1</sup>H NMR was used to demonstrate the independence of the acrylate cure from the epoxy cure in a sequential thermal polymerization. NMR allowed simultaneous monitoring of the epoxy conversion and the acrylate conversion. The protons of the oxirane ring, attached to the carbons immediately adjacent to the epoxy oxygens were detected at about 3.15 - 3.25 ppm, while the olefinic protons of the IBA were detected in the 5.7 to 6.4 ppm region. NMR showed that after partially polymerization of the free radically polymerizable monomer, only the epoxy polymerized. The epoxy proton peaks decreased as the ring opened during the polymerization, while the olefins in the acrylate remained constant.

#### Weight Loss

Various samples were prepared, coated and weighed. The samples were partially polymerized at 100°C for 90 seconds to cure the epoxy. The samples were then weighed again. The samples were then reheated at 210°C for 10 minutes to polymerize the acrylate component. The samples were then cooled and weighed for a final time to measure the total weight loss.

#### Acrylate Syrup Preparation

Three syrups each having a viscosity of approximately 2000 cps were prepared independently from IOA, IBA, and a 1:1 mixture of IOA and IBA. The syrups were prepared by adding 0.05% by weight of KB-1 to each of the acrylate(s) compositions and photolyzing with 350 nm light under a N<sub>2</sub> purge until the desired viscosity was attained of approximately 2000 cps. Samples for DMA were prepared from each of the three syrups (P1-P3) and of a fourth syrup (CEP4) comprising a 1:1 mixture of the independently polymerized IOA and IBA syrups previously prepared, each of which had been prepared by adding 0.5% by weight KB-1 to the syrups.

Each of syrups were poured into 50 x 6 x 1 mm molds, covering the molds with a conventional silicone/polyester substrate with a release

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liner and a quartz plate (approximately 5 mm thick) and exposing the molds to 350 nm light for 10 minutes to complete the polymerization. The samples were tested on a Seiko Tensile DMS 200 DMA using a 2°C/min heating rate. The  $T_g$  of the four syrups are summarized in the Table below. The results indicate the use of mixtures of syrups cause increased phase separation that is not obtained from the partially polymerization of the monomers alone.

Examples	Composition	$T_g$ (°C)
P1	partially polymerized IOA	-46
P2	partially polymerized IBA	100
P3	partially copolymerized IOA and IBA	37
CEP4	combination of P1 and P2	4 and 91

### Comparative Examples 1-5

These examples describe the preparation of epoxy-acrylate compositions wherein the epoxy-acrylate composition was photopolymerized using the process prescribed in U.S. Patent Application Serial No. 07/865,940, filed January 22, 1992. The samples were evaluated for damping characteristics using a Seiko DMS 110 rheometer and the results are summarized in Table 4. Dynamic mechanical analysis (DMA) curves, summarized below, were obtained by laminating an epoxy/polyacrylate coating between two pieces of steel (10 mm x 50 mm x 0.2 mm) and thermally cycling the constrained layer samples in the Seiko DMA-110 in the bending mode according to the following schedule: The samples were cured for 2 mins at 100°C followed by 10°C/min from room temperature to 260°C. The samples were then "parked" for 10 min at 260°C.

Run 1 -50°C to 260°C at 5°C/min, and then parked for 30min at 260°C, and

Run 2 -50°C to 260°C at 5°C/min, and then parked for 60min at 260°C, and

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Run 3 -50°C to 260°C at 5°C/min

### Comparative Example C1

This example describes preparation of an epoxy-acrylate thermoset resin wherein the epoxy-acrylate thermoset composition was photopolymerized.

A partially polymerized syrup was prepared from a mixture of acrylate monomers and a low concentration of a free radical photoinitiator. A solution of epoxy resin and cationic organometallic photoinitiator was prepared by heating the resin in the dark to about 50 to 60°C, adding the organometallic salt and stirring to complete solution. The epoxy resin solution was allowed to cool to room temperature before adding the acrylate syrup, additional free radical photoinitiator and crosslinking agent. This mixture was coated and cured using a sequential photopolymerization process. The first cure was under visible light irradiation, followed by low intensity ultraviolet irradiation. The irradiate composition was then thermally post-cured.

A partially polymerized isooctyl acrylate syrup was prepared by mixing 40 parts of IOA and 0.02 part of KB-1. The mixture was placed in a container and stirred while nitrogen gas was bubbled through the mixture to exclude oxygen. The mixture was irradiated with low intensity ultraviolet light until a viscous partially polymerized syrup was obtained.

Similarly, in a separate container a partially polymerized isobornyl acrylate syrup was prepared by mixing 5 parts of IBA and 0.0025 part of KB-1. The mixture was placed in a container and stirred while nitrogen gas was bubbled through the mixture to exclude oxygen. The mixture was irradiated with low intensity ultraviolet light until a viscous partially polymerized syrup was obtained having a viscosity in the range of 1000-3000 cps measured on a Brookfield Viscometer using spindle RV6 at a speed of 100.

In a separate container, 10 parts of EPON 1001F and 90 parts of ERL 4221 were heated to 150°C for 30 minutes and allowed to mix. The mixture was cooled to 60°C while stirring, then 0.5 part of

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Cp(Xyl)FeSbF<sub>6</sub> was added in the dark. The epoxy mixture was stirred until the catalyst dissolved and then the mixture was allowed to cool to room temperature.

5 In a separate container, and in the dark, were mixed 55 parts of the epoxy mixture, then 40 parts of the partially polymerized IOA syrup, 5 parts of the partially polymerized IBA syrup, 0.22 part of KB-1 and 0.16 part of HDDA. This mixture, stirred to insure complete mixing of the components, was then evacuated in a metal bell jar to remove oxygen and bubbles.

10 The resultant composition was knife coated to a wet coating film thickness of about 50 micrometers between two sheets of polyester previously coated with a silicone release layer. The coated sandwich was passed through two (2) irradiation zones. Zone 1 was an approximately 0.60 m section and heated to 80 to 90°C. The zone had two 500 watt  
15 quartz/halogen lamps as the light sources. Zone 2 was an approximately 3.7 m section and had low intensity ultraviolet lights. The coating speed was approximately 43 cm·min<sup>-1</sup>. After passing through the two exposure zones, the samples were post-cured at 100°C for 15 minutes.

The epoxy-acrylate resin was evaluated as in Comparative Example  
20 1 and the results are summarized in Tables 4 and 5.

#### Comparative Examples C2-C5

Epoxy-acrylate thermoset resins were prepared according to the procedure described Comparative Example 1 using the components and  
25 amounts summarized in Tables 1A and 1B:

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Table 1A

Examples	Acrylate Syrup		Epoxy Mixture		
	IOA	IBA	ERL4221	EPON 1001F	CpXylFeSbF <sub>6</sub>
C2	30	15	49.5	5.5	0.27
C3	22.5	22.5	49.5	5.5	0.27
C4	15	30	49.5	5.5	0.27
C5	5	40	49.5	5.5	0.27

Table 1B

Examples	Epoxy-Acrylate Mixture			
	Acrylate Syrup	Epoxy Mixture	HDDA	KB-1
C2	45	55	0.09	0.22
C3	45	55	0.09	0.22
C4	45	55	0.09	0.22
C5	45	55	0.09	0.22

**Examples 6-10**

These examples describe the preparation of epoxy-acrylate compositions wherein the epoxy component was thermally polymerized and the acrylate component was photopolymerized. The specific components and amounts are summarized in Table 2. The samples were evaluated for damping characteristics using a Seiko DMS 110 rheometer and the results are summarized in Tables 4 and 5.

Acrylate syrups and epoxy mixtures were prepared according to the procedure described in detail in Comparative Example 1. The epoxy component was added to the acrylate syrups in the ratios identical to those used in Comparative Examples C1-C5.

Each sample was prepared by dissolving 0.275 parts of Cp<sub>2</sub>FeSbF<sub>6</sub> in several drops of methyl sulfolane. 0.275 parts of DEOT and 0.225 parts of KB-1 were then added to the solution. An epoxy-acrylate mixture prepared using the components and amounts summarized in Table 2 was

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added to the solution of initiators. The composition was then stirred, degassed and knife-coated as described in Example C1. The coating was then cured for four minutes at 100°C, followed by exposure to low intensity UV lights for 5 minutes. The partially polymerized ("B-staged") film was laminated between two pieces of 0.3 mm (0.012") thick steel by 5  
subjecting the film to 100°C for 2 minutes and brought to a final cure in a rheometer between -80° and 260°C using a 10°C/minute heating rate. The material was evaluated in the Seiko DMS 110 20 mm bending fixture using the heating cycle as described in Comparative Example C1 and the 10  
results are summarized in Tables 4 and 5.

### Examples 11-15

These examples describe the preparation of epoxy-acrylate compositions wherein both the epoxy component and the acrylate 15  
component were thermally polymerized.

Acrylate syrups and epoxy mixtures were prepared according to the procedure described in detail in Examples 6-10. The epoxy component was added to the acrylate syrups in the ratios identical to those used in Examples 6-10.

20 The samples were prepared by dissolving the  $\text{Cp}_2\text{FeSbF}_6$  in several drops of methyl sulfolane, after which the DEOT were added to the solution. An epoxy/acrylate mixture prepared using the components and amounts summarized in Table 2 was added to the solution of initiators.

To this mixture 0.225 parts of Trigonox-29 were added. The 25  
composition was then stirred and degassed as in Example 6. The degassed mixture was rod coated onto an about 75 mm x 75 mm (about 3 inch x 3 inch) steel sheet 0.3 mm (0.012 inch) thick. A similar steel sheet was placed on top of the coated mixture. The resulting laminate was then thermally cured for five minutes at 100°C. The laminate was 30  
evaluated in the Seiko DMS 110 in 20 mm bending fixture using the heating cycle described in Example C1 and the results are summarized in Tables 4 and 5.



Table 2

Examples	Acrylate Syrup		Epoxy Mixture		Epoxy-Acrylate Mixture			
	IOA	IBA	ERL 4221	EPON 1001F	Acrylate Syrup	Epoxy Mixture	HDDA	KB-1 (6-10) Trignox-29 (11-15)
6	40	5	49.5	5.5	45	55	0.09	0.275
7	30	15	49.5	5.5	45	55	0.09	0.275
8	22.5	22.5	49.5	5.5	45	55	0.09	0.275
9	15	30	49.5	5.5	45	55	0.09	0.275
10	5	40	49.5	5.5	45	55	0.09	0.275
11	40	5	49.5	5.5	45	55	0.09	0.275
12	30	15	49.5	5.5	45	55	0.09	0.275
13	22.5	22.5	49.5	5.5	45	55	0.09	0.275
14	15	30	49.5	5.5	45	55	0.09	0.275
15	5	40	49.5	5.5	45	55	0.09	0.275

Cp<sub>2</sub>FeSbF<sub>6</sub>

Table 3

Examples	Acrylate Syrup		Epoxy Mixture		Epoxy-Acrylate Mixture			
	IOA	IBA	ERL 4221	EPON 1001F	Acrylate Syrup	Epoxy Mixture	HDDA	KB-1 (16-20) Trigonox-29 (21-25)
16	40	5	49.5	5.5	45	55	0.09	0.225
17	30	15	49.5	5.5	45	55	0.09	0.225
18	22.5	22.5	49.5	5.5	45	55	0.09	0.225
19	15	30	49.5	5.5	45	55	0.09	0.225
20	5	40	49.5	5.5	45	55	0.09	0.225
21	40	5	49.5	5.5	45	55	0.09	---
22	30	15	49.5	5.5	45	55	0.09	---
23	22.5	22.5	49.5	5.5	45	55	0.09	---
24	15	30	49.5	5.5	45	55	0.09	---
25	5	40	49.5	5.5	45	55	0.09	---

Mes<sub>2</sub>Fe(SBF<sub>6</sub>)<sub>2</sub>

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**Examples 16-20**

These examples describe the preparation of epoxy-acrylate compositions wherein the epoxy component was thermally polymerized and the acrylate component was photopolymerized.

- 5        Acrylate syrups were prepared according to the procedure described in Example C1. Similarly, the epoxy mixture was prepared as described Example C1. The epoxy component was then added to the acrylate syrups in the ratios identical to those used in Examples C1-C5.

- Each sample was prepared by dissolving 0.275 parts of  
10     $(\text{Mes})_2\text{Fe}(\text{SbF}_6)_2$  in several drops of methyl sulfolane. 0.225 parts of KB-1 were then added to the solution. An epoxy/acrylate mixture prepared the components and amounts summarized in Table 3 was added to the solution of initiators.

- The composition was then stirred, degassed and knife coated as  
15    described in Example C1. The film was then cured for four minutes at 100°C, followed by exposure to low intensity ultraviolet (UV) lights for 5 minutes. The resulting B-staged film was laminated between two pieces of 0.3 mm (0.012 inch) thick steel and brought to a final cure in a rheometer between -80° and 260°C using a 10°C/minute heating rate.  
20    The material was evaluated in the Seiko DMS 110 in 20 mm bending fixture using the heating cycle schedule described in Example C1 and the results are summarized in Tables 4 and 5.

**Examples 21-25**

- 25        These examples describe the preparation of epoxy-acrylate compositions wherein both the epoxy component and the acrylate component were thermally polymerized.

- Acrylate syrups and epoxy mixtures were prepared according to the procedure described below and in further detail in Example C1. The  
30    epoxy component was then added to the acrylate syrups in the ratios identical to those used in Examples 6-10.

Each sample was prepared by dissolving 0.275 parts of  
 $(\text{Mes})_2\text{Fe}(\text{SbF}_6)_2$  in several drops of methyl sulfolane. An epoxy/acrylate

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mixture prepared using the components and amounts summarized in Table 3 was added to the solution of initiators.

To this mixture 0.225 parts of Trigonox-29 were added. The composition was then stirred and degassed as described in Example C1.

- 5 The degassed mixture was rod coated onto an about 75 X 75 mm (3 inch x 3 inch) steel sheet 0.3 mm (0.012") thick, and a similar sheet was placed on top of the organic layer. The resulting laminate was then cured for five minutes at 100°C. The material was evaluated in the Seiko DMS 110 in 20 mm bending fixture using the heating cycle described in
- 10 Example C1 and the results are summarized in Tables 4 and 5.

- Table 4 shows striking differences in the initial damping performance, as well as in the "annealed" samples. The samples prepared using the catalysis and the cure schedule described in Comparative Examples C1-C5 (based on Serial No. 07/865,940, filed January 22,
- 15 1992) appear under the "two color" heading. The useful thermal damping ranges of these compositions are narrow, generally not exceeding 20°C wide at  $\tan \delta > 0.06$ . In contrast, using the thermally cured compositions of the present invention, these ranges are greatly expanded, regardless whether the thermal or photo, sequential or simultaneous
- 20 initiation of the acrylate polymerization are used.

**Table 4**  
**Effect of Processing on the Morphology and Thermal Stability (Effective Damping Range)**

**Table 5**  
**Effect of Processing on the Morphology and Thermal Stability ( $T_{\text{max}} \delta$ )**

Composition (%)			Two Color (Examples C1-C5)		UV, Thermal (Examples 6-10)		Thermal, Thermal (Examples 11-15)	
Epoxy	IOA	IBA	initial maximum damping	maximum damping after 100 min at 260°C	initial maximum damping	maximum damping after 100 min at 260°C	initial maximum damping	maximum damping after 100 min at 260°C
55	40	5	0.15	0.13	0.09	0.16	0.21	0.22
55	30	15	0.083	0.042	0.14	0.084	0.094	0.101
55	22.5	22.5	0.061	0.048	0.11	0.10	0.088	0.067
55	15	30	0.061	0.051	0.065	0.05	0.095	0.083
55	5	40	0.045	0.022	0.09	0.07	0.064	0.063
(Examples C1-C5)								
(Examples 15-20)								
55	40	5	0.15	0.13	0.123	0.114	0.090	0.078
55	30	15	0.083	0.042	0.152	0.114	0.085	0.059
55	22.5	22.5	0.061	0.048	0.17	0.098	0.065	0.031
55	15	30	0.061	0.051	0.11	0.051	0.057	0.040
55	5	40	0.045	0.022	0.081	0.12	0.081	0.057

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The samples prepared according to the present invention, show superior thermal stability to those polymerized via the two color process. They show minimal or no decrease in damping ability after 100 minute exposure to 260°C, whereas none of the two color materials survived that test. Moreover, only Example C3 survived even a 30 minute exposure to this temperature.

The effect of the prolonged exposure to elevated temperatures can be monitored by tracking the magnitude of the  $\tan \delta_{\max}$ , or the peak. In Table 5, the samples prepared by all processes were compared that way.

Tables 4 and 5 demonstrate the multi-color process produced morphologies dominated by the acrylates, as evidenced by the initial prominence of the low temperature peak. Because the contribution to the morphology from the more thermally stable epoxy phase was minimal, these samples degraded after relatively short times at 260°C. Their maximum damping decreased to the point where no peak was discernable over a very low  $\tan \delta$  baseline.

In contrast, many of the samples prepared according to the present invention showed initially wide useful thermal damping ranges and expanded even further after a 100 minute anneal at 260°C. The epoxy rich phase was clearly visible in the dynamic mechanical analysis in the samples prior to the anneal. The epoxy component was intimately mixed with the acrylate on submicron levels to afford the microheterogeneously phase separated morphology in which the high temperature epoxy rich phase thermally protected the acrylate.

#### Example 26

A syrup of isobornyl acrylate with a viscosity of about 2000 cps was dissolved in ERL4221 in various ratios from 70/30 to 50/50. The monomeric solutions were then polymerized using a variety of processes with a range of free radical catalysts. DSC results from the 50/50 and 30/70 compositions with cure exotherm peak temperatures and exotherm magnitudes are summarized in Table 6. Other organometallics, such as bis(mesitylene)iron(+2) hexafluoroantimonate do not provide two

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separate thermal cures for each component. With AIBN and Trigonox-29, DSC scans indicated a single peak for simultaneous cures.  $\text{Cp}_2\text{FeSbF}_6$  was also unique among the cationic organometallic catalysts in its insensitivity to photolysis.



**Table 6**  
**DSC Summary of Cp<sub>2</sub>FeSbF<sub>6</sub> Interaction with Various Free Radical Initiators**

Cure Condition		No Cationic Catalyst		With 0.5% Cationic Catalyst		
Free Radical Catalyst (0.5%)	% Composition Epoxy/Acrylate	Energy of Exotherm (J/g)	Peak Temperature (°C)	Normalized energy of epoxy exotherm (J/g)	Normalized energy of acrylate exotherm (J/g)	Peak Temperatures (°C) epoxy, acrylate
Trigonox-29	30/70	311	117	267	334	98, 143
Trigonox-B	30/70	170	161	203	290	142, 171
V-19	50/50	280	162	235	388	83, 164
V-30	50/50	287	139	119	362	110, 150
VR-110	50/50	330	159	363	253	88, 174
VR-160	50/50	259	174	378	341	109, 202

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**Example 27**

During some all-thermal cure processes, the monomer might be exposed to air. To monitor the acrylic weight loss due to the monomer evaporation versus the polymerization, these conditions were simulated by curing thin monomeric layers spread as open faced sandwiches on steel plates. Extreme thermal conditions were chosen to demonstrate the compositions can withstand severe temperatures with minimal weight loss even during such cures. The samples were heated to 210°C, a temperature about 65°C below the boiling point of the acrylate. They were cured in the hood with an air flow at 125 ft/min, further aiding the monomer evaporation.

Six monomer samples were prepared as described in Example 26, coated and weighed. They were then "B-staged" at 100°C in the hood for 90 seconds to cure the epoxy and weighed again. The results in Table 7 summarize the relative weight losses of the samples after the first temperature bump. The samples were then reheated at 210°C for 10 minutes to polymerize the acrylate. The samples were then cooled and weighed for the final time to measure the total weight loss. Under the extreme conditions and without any cure optimizing, only 20% weight loss was observed with three free-radical catalysts.

**Table 7**  
**Monomer Weight Loss**  
**with Various Free Radical Initiators**  
**During an Open Face Cure**

FR Initiator Used	VR-160	VR-100	TRIG-B	TRIG29	V19	V30
Net Monomer Wt (initial weight)	0.8730	0.9953	0.7304	0.9517	1.072 2	0.848 0
Weight Loss after 1st Bump	0.1139	0.1048	0.1352	0.1186	0.095 4	0.096 7
Weight Loss after 2nd Bump	0.2200	0.2096	0.2575	0.1897	0.210 2	0.259 7
%Total Wt Loss	25.20	21.06	35.25	19.93	19.60	30.63

### Examples 28-30

The various samples are useful in illustrating the present invention. A polymerization composition of IBA/ERL4221 with 0.5% by weight of the cationic catalyst system and 0.5% by weight of a free radical initiator was prepared and the morphology was altered by adjusting various conditions and components. The system was rendered completely miscible and completely phase separated. The following examples illustrate how a variety of morphologies in between can be prepared with the control allowed by the present invention.

Two types of samples were prepared. The first set was photoinitiated using KB-1 in the UV between two release liners to polymerize the acrylate phase first. The samples were then prepared by placing the resulting free standing film between two plates of steel and heat curing the epoxy phase at 200°C for 30 minutes. These were the "control" samples.

The second set of samples were further divided into the "simultaneous" and "sequential" curing processes. In the case of sequential curing, the epoxy phase was first cured at 100°C. Then the free radical catalyst was "released" by heating the sample at the temperature characteristic for the 10 hour half life of a given initiator, typically in the range between 130 and 220°C.

The "simultaneous" category samples were prepared as follows: the monomer with the added catalysts was coated between two steel sheets. The sandwich was then placed in an oven at 200°C for 10 minutes.

Under the first processing conditions, the monomeric mixture with KB-1 added as the UV sensitive free radical initiator was knife coated between two transparent plastic sheets and irradiated in near UV for 5 minutes to cure the acrylate first. Subsequently, the UV cured film was removed and sandwiched between rigid constraining layers. The construction was then heat cured at 200°C for 10 minutes. Reviewing the results summarized in Tables 8-10, the DMA results indicate the morphology of the compositions were governed by acrylate thermal

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transitions, that is, the epoxy phase played no visible role in the resulting morphology. In Tables 8-10 the notation "UV" indicates a photocure, and "HT" indicates a thermal cure.

However, if the minor epoxy component was thermally polymerized first, the damping range of the sample row shift to much higher temperatures. Moreover, the transition spans a broader range. This type of morphological differences are best illustrated by the comparison of the UVHT 40/60 sample in the Table 8 (Run 1), with some of the HTHT 40/60 samples.

**Table 8**  
**Effect of Processing and Catalysis on Morphology**  
**50:50 IBA:ERL-4221 composition (Example 28)**

UV:KB-1, HT			HT:VR-110, HT			HT:VR-160, HT		
Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$
S1:1	80-110 148-196	78	1	58-75 82-172	107	1	70-135	65
S1:2	80-115 177-196	64	2	112-191	79	2	80-140	60
S2:1	79-153	74	3	118-193	75	3	82-147	63

**Table 9a**  
**Effect of Processing and Catalysis on Morphology**  
**60:40 IBA:ERL-4221 composition (Example 29)**

UV:KB-1, HT			HT:VR-110, HT			HT:VR-160, HT		
Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$
1	45-85	40	1	67-120	57	1	92-153	61
2	52-97	45	2	77-129	52	2	116-166	50
3	59-106	47	---	---	---	3	118-175	57
4	58-107	49	---	---	---	---	---	---

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Table 9b

Simultaneous Thermal			HT: Trigonox B, HT			HT: Trigonox-29, HT		
Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$
S1:1	47-166	119	1	82-132	50	1	86-131	45
S1:2	65-152	87	2	79-149	70	2	88-137	49
S2:1	62-140	78	---	---	---	---	---	---
S2:2	61-90	29	---	---	---	---	---	---

Table 9c

HT:V-30, HT			HT:VR-19, HT		
Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$
1	53-124	71	1	52-132	80
2	56-129	73	2	51-133	82

Table 10a

Effect of Processing and Catalysis on Morphology  
30:70 IBA:ERL-4221 Composition (Example 30)

UV:KB-1, HT			Simultaneous Thermal		
Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$
1	85-122	37	1	87-136	49
2	84-123	39	2	88-156	68

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Table 10b

HT:VR-110, HT			HT:VR-160, HT		
Run #	$\tan \delta > 0.06$	$\Delta$	Run #	$\tan \delta > 0.06$	$\Delta$
S1:1	56-117	61	1	50-139	89
S1:2	63-128	78	2	78-139	61
S2:1	66-144	65	---	---	---
S2:2	76-140	64	---	---	---

5

10 Various modifications and alterations of this invention will become apparent to those skilled in the art without departing from the scope and spirit of this invention, and it should be understood that this invention is not to be unduly limited to the illustrative embodiments set forth herein.

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## Claims:

1. A curable composition comprising a mixture of at least one free radically polymerizable monomer, at least one epoxy functional  
5 monomer, at least one free radical polymerization initiator, a thermal initiated cationic catalyst system comprising a salt of an organometallic cation, wherein when cured the curable mixture provides a vibration damping material with an interpenetrating network comprising a semi-phase separated morphology.
- 10 2. The curable composition according to claim 1 further comprising at least one stabilizing additive.
3. The curable composition according to claim 1 further at least  
15 one alcohol-containing material.
4. The curable composition according to claim 1 wherein the free radically polymerizable monomers are acrylate or methacrylates.
- 20 5. The curable composition according to claim 1 wherein the free radically polymerizable monomers are partially polymerized.
6. The curable composition according to claim 1 wherein the free radical polymerization initiator is either thermally or photochemically  
25 initiated.
7. A vibration damping construction comprising:
  - (1) at least one substrate;
  - (2) a cured viscoelastic layer coated on the substrate comprising  
30 an interpenetrating network of prepared from a curable composition comprising:
    - (a) at least one free radically polymerizable monomer,
    - (b) at least one epoxy functional resin,

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- (c) at least one free radical polymerization initiator, and  
 (d) a thermally-initiated cationic catalyst system comprising  
 (i) at least one salt of an organometallic cation,  
 wherein the organometallic cation is selected from a class of substituted  
 5 and unsubstituted aromatic compounds based on a benzene or  
 cyclopentadienyl nucleus, the metal is a transition metal and the anion is  
 tetrafluoroborate, hydroxypentafluoroantimonate,  
 trifluoromethanesulfonate, hexafluorophosphate, hexafluoroarsenate, or  
 hexafluoroantimonate; and  
 10 (ii) optionally, at least one stabilizing additive;  
 (e) optionally, at least one alcohol-containing material; and  
 (f) optionally, additional adjuvants.

8. A vibration damping construction comprising:  
 15 (a) a first substrate;  
 (b) the cured viscoelastic layer according to claim 1 coated on  
 at least one surface of the first substrate; and  
 (c) optionally, a second substrate positioned over the  
 viscoelastic layer such that the layer is sandwiched between the first and  
 20 second substrates.

9. A method for preparing a vibration and sound absorbing  
 construction comprising the steps of:  
 (1) providing a first substrate;  
 25 (2) preparing a curable mixture according to claim 1 comprising  
 (a) at least one acrylate and/or methacrylate, (b) at least one epoxy  
 functional resin, (c) at least one free radical polymerization initiator, and  
 (d) thermally-initiated catalyst system comprising  
 (i) a salt of an organometallic cation having the formula;



wherein:

M is selected from the group consisting of Cr, Mo, W, Mn, Re, Fe, Ru,  
 and Os;



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$L^1$  represents ligands contributing  $\pi$ -electrons that can be selected from substituted and unsubstituted aromatic compounds and substituted and unsubstituted heterocyclic aromatic compounds, and capable of contributing six  $\pi$ -electrons to the valence shell of M;

5  $L^2$  represents ligands contributing  $\pi$ -electrons that can be selected from substituted and unsubstituted cyclopentadienyl and indenyl anions, and capable of contributing six  $\pi$ -electrons to the valence shell of M;

m and p are integers having a value of 0 or 2, such that, when m is equal to 2, each  $L^1$  may be the same or different ligands and p is equal to 0; and when p is equal to 2, each  $L^2$  may be the same or different ligands and m is equal to 0, provided the sum of (m + p) is equal to 2;

15 q is an integer having a value of 1 or 2, the residual charge of the complex cation;

X is an anion selected from organic sulfonate anions selected from the group consisting of  $\text{CH}_3\text{SO}_3^-$ ,  $\text{CF}_3\text{SO}_3^-$ ,  $\text{C}_6\text{H}_5\text{SO}_3^-$ , p-toluenesulfonate, p-chlorobenzenesulfonate and related isomers, and halogen-containing complex anions of a metal or metalloid selected from the group consisting of  $\text{BF}_4^-$ ,  $\text{AsF}_6^-$ ,  $\text{PF}_6^-$ ,  $\text{SbF}_5\text{OH}^-$ ,  $\text{SbF}_6^-$ , and  $\text{CF}_3\text{SO}_3^-$ ; and

n is an integer having a value of 1 or 2, the number of complex anions required to neutralize the charge q on the complex cation; and

(ii) optionally, a stabilizing additive;

25 (3) coating the curable mixture onto the first substrate;

(4) exposing the coating to energy to partially cure component

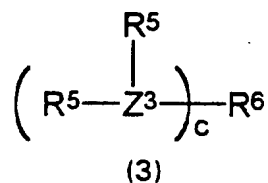
(a) by activating the free radical initiator;

(5) laminating the partially cured coating between the first substrate, and a second substrate; and

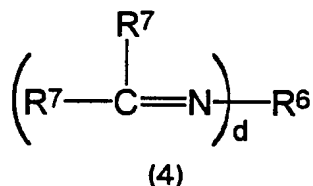
30 (6) exposing the laminate to a temperature sufficient to cure component (b) to provide a fully cured coating laminated between the first and second substrates.

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10. The method according to claim 5 wherein the stabilizing additive is a compound have segments or central nucleus a formula selected from the group consisting of



5



wherein

$\text{Z}^3$  is nitrogen, phosphorus, arsenic or antimony;

$\text{R}^5$  is a radical moiety that can be the same or different and is selected from substituted and unsubstituted  $\text{C}_1$  to  $\text{C}_{10}$  alkyl groups,

10 substituted and unsubstituted groups of one to four aromatic rings, wherein two to four rings can be fused or unfused rings;

$\text{R}^6$  is hydrogen or  $\text{R}^5$ ; furthermore, when  $\text{R}^6$  is  $\text{R}^5$ ,  $\text{R}^5$  and  $\text{R}^6$  can be taken together to form a cyclic ring having 5 to 7 ring atoms;

$\text{R}^7$  is  $\text{R}^5$  or divalent group (as when  $d = 2$ ) selected from alkylene, having  
15 3 to 10 carbon atoms and phenylene groups;

$c$  is 1 or 2; and

$d$  is 1 or 2.

11. The method according to claim 9 wherein one or more free  
20 radically polymerizable monomer is partially polymerized prior to the polymerization of the epoxy functional monomer.

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12. The method according to claim 11 wherein each free radically polymerizable monomer is separately partially polymerized and then mixed together before adding one or more epoxy functional monomers.

5

13. The method according to claim 12 wherein the free radically polymerizable monomers are exposed to irradiation energy level to effectively partially polymerize the monomers.

10 14. The method according to claim 12 wherein the free radically polymerizable monomers are subjected to a temperature sufficient to partially polymerize the monomers.

15 15. The method according to claim 9 wherein the first substrate is a releasable carrier web, wherein component (a) is partially cured, and then laminated onto a second substrate, after which the releasable carrier web is removed and a third substrate is added to form a sandwich with the viscoelastic material between the second and third substrate.

20 16. A method comprising the steps:

(a) providing a polymerizable mixture comprising at least one free radically polymerizable monomer and at least one epoxy functional monomer, a free radical polymerization initiator, a cationic catalyst system, wherein the catalyst system for the epoxy functional  
25 monomer comprises at least one salt of an organometallic cation, and  
(b) controlling the rates of polymerization and diffusion of each component monomer to provide at least one of a phase separated or phase mixed morphology.

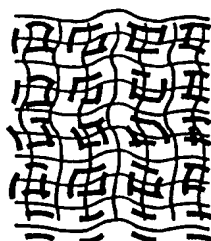


FIG.1A

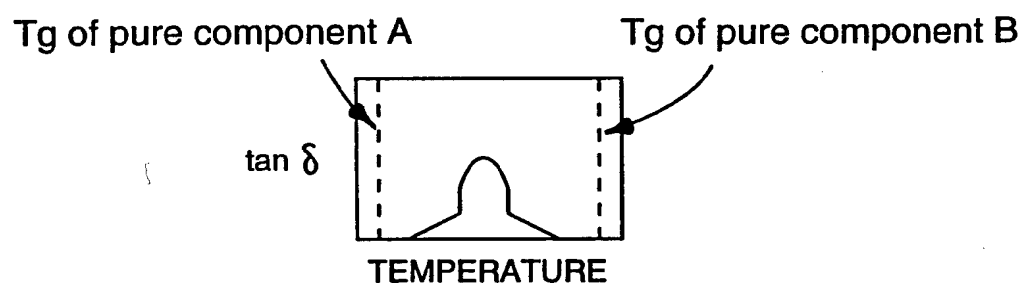


FIG.1B



FIG.1C

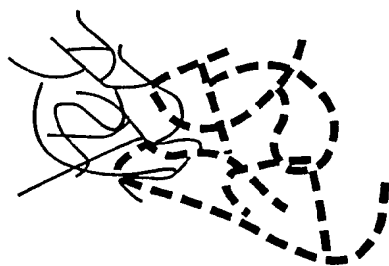


FIG.2A

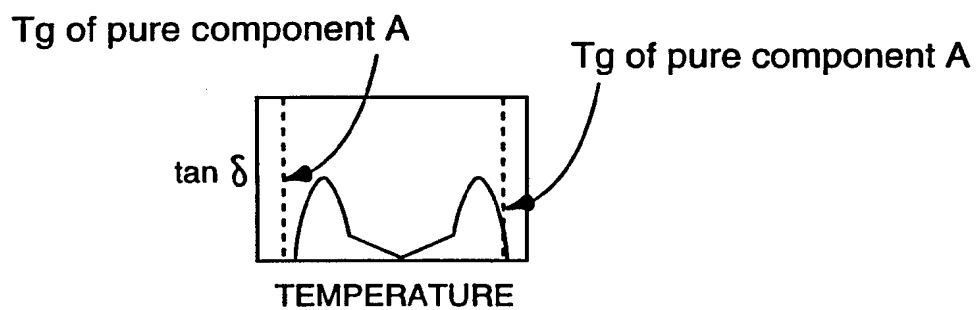


FIG.2B

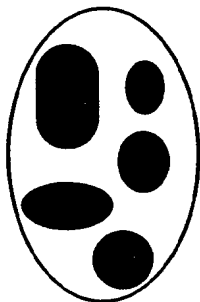


FIG.2C

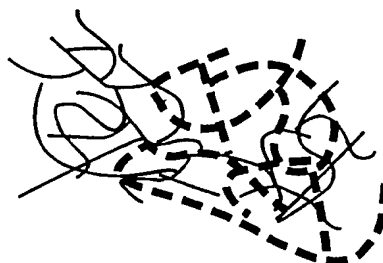


FIG.3A

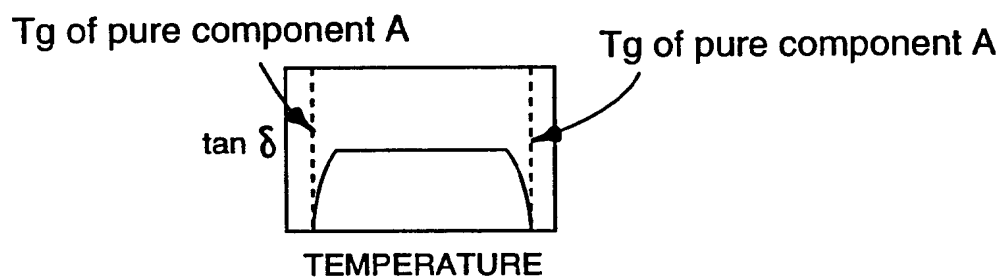


FIG.3B

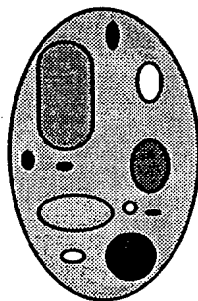


FIG.3C

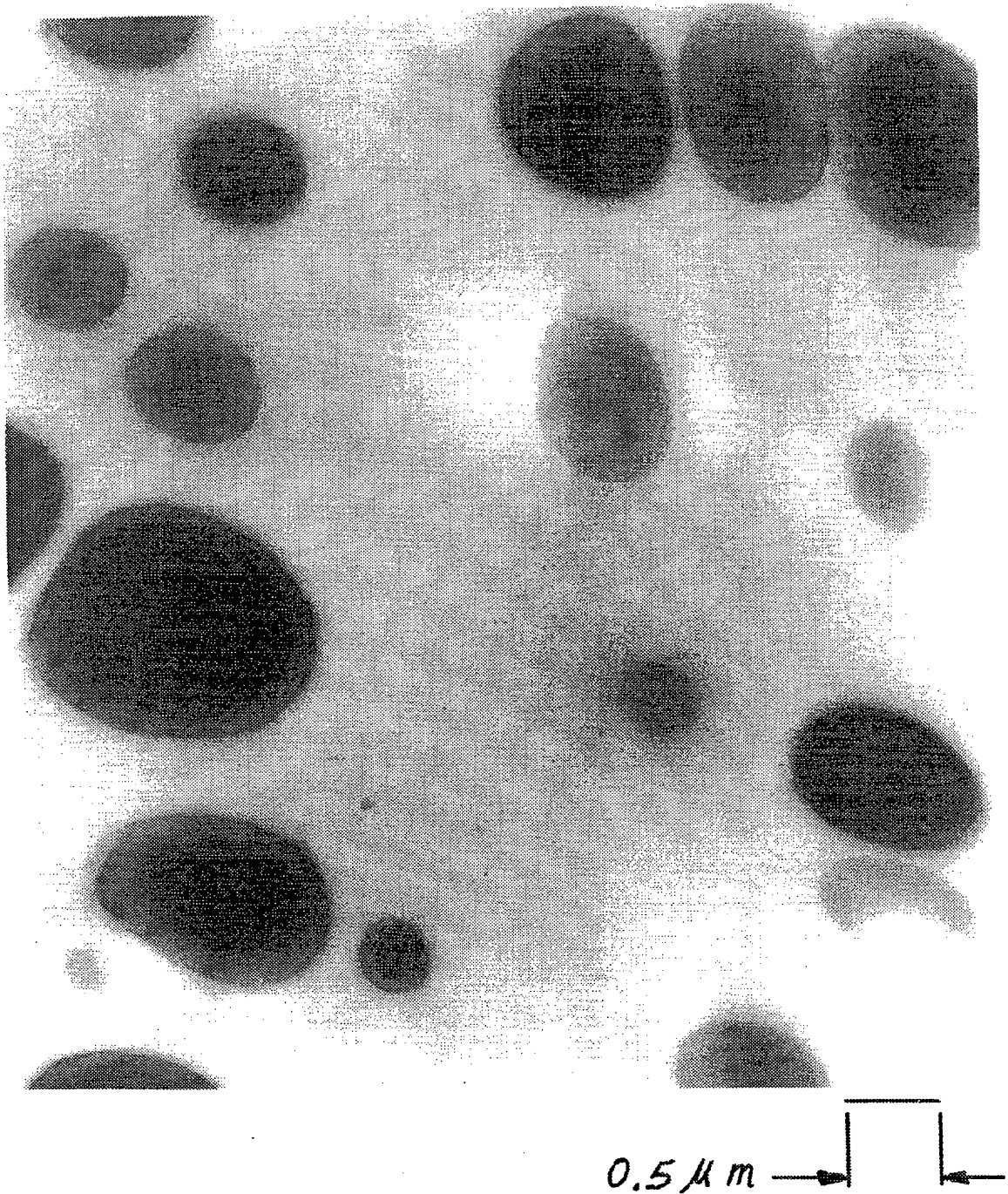


FIG. 4

## INTERNATIONAL SEARCH REPORT

International application No.  
PCT/US 94/04829

## A. CLASSIFICATION OF SUBJECT MATTER

IPC 5 C08F220/32 C08F283/10 C08G59/68

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 5 C08F C08G

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US,A,4 426 431 (AKZO N.V.) 16 August 1990 see claim 1	1
Y	--- EP,A,0 542 716 (MINNESOTA MINING AND MANUFACTURING COMPANY) 19 May 1993 see claim 1	1
A	--- EP,A,0 306 162 (MINNESOTA MINING AND MANUFACTURING COMPANY) 8 March 1989 -----	



Further documents are listed in the continuation of box C.



Patent family members are listed in annex.

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Date of the actual completion of the international search

22 September 1994

Date of mailing of the international search report

17. 10. 94

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# INTERNATIONAL SEARCH REPORT

information on patent family members

International application No.  
PCT/US 94/04829

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